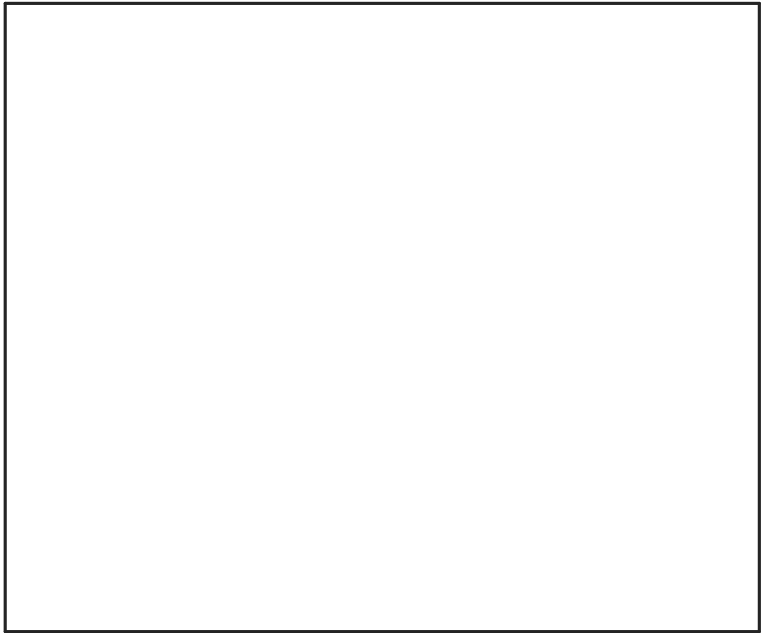


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9770	REV: E1	SUN REV: Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 12/29/2014 4:17:02 PM		TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9770	REV: E1	SUN REV: Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/29/2014 4:17:03 PM	TEXAS INSTRUMENTS	

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